

8 A MOLD THYRISTOR

DESCRIPTION

The 8P4J and 8P4J-Z are P-gate all diffused mold type THYRISTOR granted average on-state current 8 Amps ($T_c = 90^\circ\text{C}$), with rated voltages up to 400 Volts.

FEATURES

- Small and Surface Mount package.
- High junction temperature provides free application design.
- 80 A surge current.

APPLICATIONS

Automotive application such as regulator, Speed control of motor.

Various temperature control, Electronic jar.

Various solid state relay etc.

MAXIMUM RATINGS

| ITEM | SYMBOL | MAXIMUM RATINGS | UNIT | NOTE |
|--|--------------|---|------------------------|---------|
| Non-Repetitive Peak Reverse Voltage | V_{RSM} | 500 | V | |
| Non-Repetitive Peak-off Voltage | V_{DSM} | 500 | V | |
| Repetitive Reverse Voltage | V_{RRM} | 400 | V | |
| Repetitive Peak-off Voltage | V_{DRM} | 400 | V | |
| On-state Current | $I_{T(AV)}$ | 8 ($T_c = 90^\circ\text{C}, \theta = 180^\circ$ Single Phase half wave) | A | Fig. 11 |
| | $I_{T(RSM)}$ | 12.6 | | |
| Surge On-state Current | I_{TSM} | 80 | A | Fig. 2 |
| Critical Rate-Rise of On-State Current | di/dt | 50 | $\text{A}/\mu\text{s}$ | |
| Gate Power Dissipation | PGM | 5 ($f \geq 50 \text{ Hz}, \text{Duty} \leq 10\%$) | W | Fig. 3 |
| Gate Power Dissipation | $PG(AV)$ | 0.5 | W | |
| Gate Forward Current | I_{FGM} | 2 ($f \geq 50 \text{ Hz}, \text{Duty} \leq 10\%$) | A | |
| Gate Reverse Voltage | V_{RGM} | 10 | V | |
| Junction Temperature | T_j | -40 to +125 | $^\circ\text{C}$ | |
| Storage Temperature | T_{stg} | -55 to +150 | $^\circ\text{C}$ | |

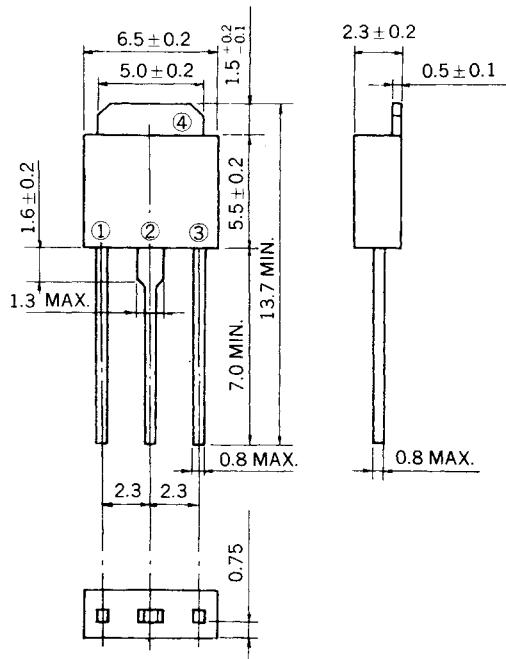
ELECTRICAL CHARACTERISTICS ($T_j = 25^\circ\text{C}$)

| CHARACTERISTIC | SYMBOL | CONDITION | MIN. | TYP. | MAX. | UNIT | NOTE |
|--|----------------------|---|------|------|------|------------------|----------------------|
| Repetitive Peak Reverse Current | I _{RRM} | $V_{RM} = 400 \text{ V}, T_j = 125^\circ\text{C}$ $R_{GK} = 1 \text{ k}\Omega$ | — | — | 2 | mA | |
| Repetitive Peak Off-state Current | I _{DRM} | $V_{DM} = 400 \text{ V}, T_j = 125^\circ\text{C}$ $R_{GK} = 1 \text{ k}\Omega$ | — | — | 2 | mA | |
| On-state Voltage | V _{TM} | I _{TM} = 10 A | — | — | 1.4 | V | See Fig. 1 |
| Gate-Trigger Current | I _{GT} | $V_{DM} = 6 \text{ V}, R_L = 100 \Omega$ | — | — | 10 | mA | See Fig. 5 Fig. 7 |
| Gate-Trigger Voltage | V _{GT} | $V_{DM} = 6 \text{ V}, R_L = 100 \Omega$ | — | — | 1.5 | V | See Fig. 6 Fig. 8 |
| Gate Non-Trigger Voltage | V _{GD} | $V_{DM} = 200 \text{ V}, T_j = 125^\circ\text{C}$ | 0.2 | — | — | V | |
| Critical Rate-of-Rise of Off-state Voltage | dv/dt | $V_{DM} = 270 \text{ V}, T_j = 125^\circ\text{C}$ | — | 40 | — | V/ μs | |
| Holding Current* | I _H | $V_D = 24 \text{ V}, I_{TM} = 10 \text{ A}$ | — | 6 | — | mA | See Fig. 9 |
| Thermal Resistance | R _{th(j-c)} | Junction to Case | — | — | 2.3 | °C/W | See Fig. 13 |
| | R _{th(j-a)} | Junction to Ambient* | — | — | 62.5 | °C/W | |

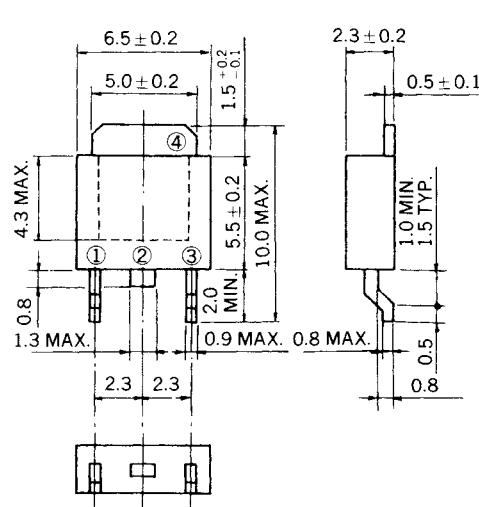
* Mount on 7.5 cm² x 0.7 mm ceramic substrate

PACKAGE DIMENSIONS (in millimeters)

8P4J



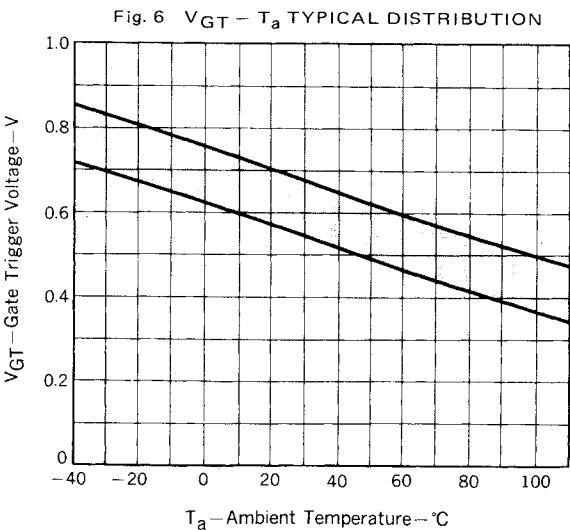
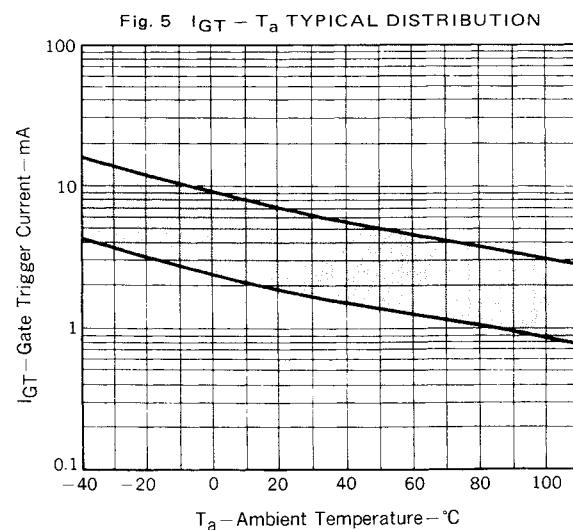
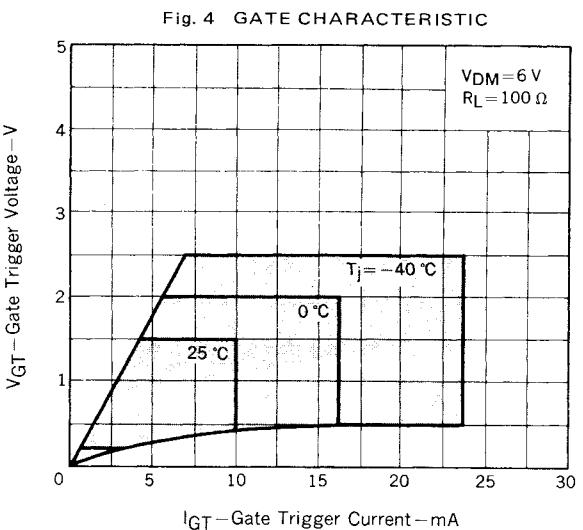
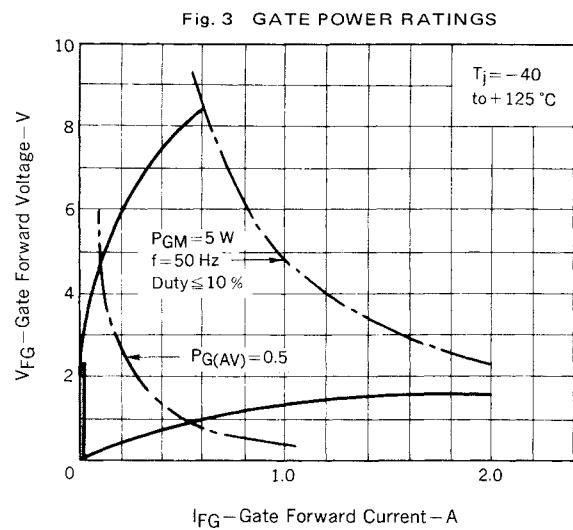
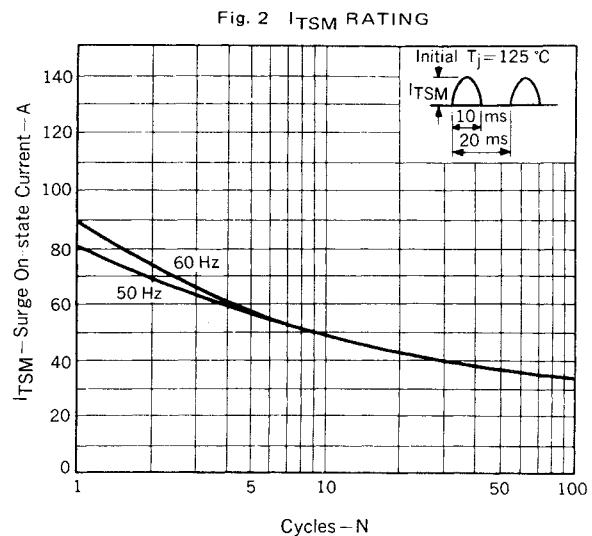
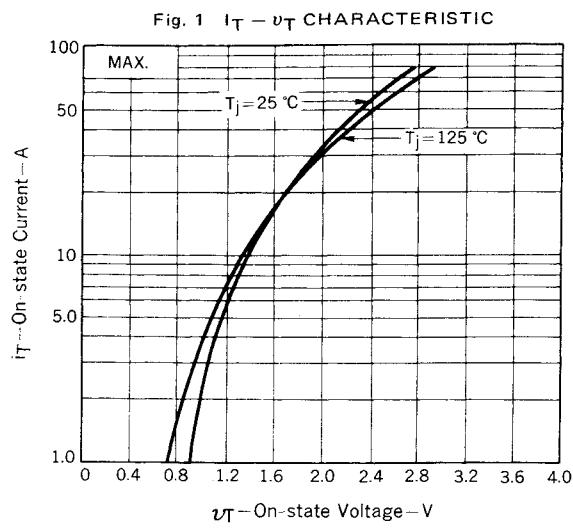
8P4J-Z



Pin Connection

1. Cathode
2. Anode
3. Gate
4. Fin (Anode)

CHARACTERISTIC



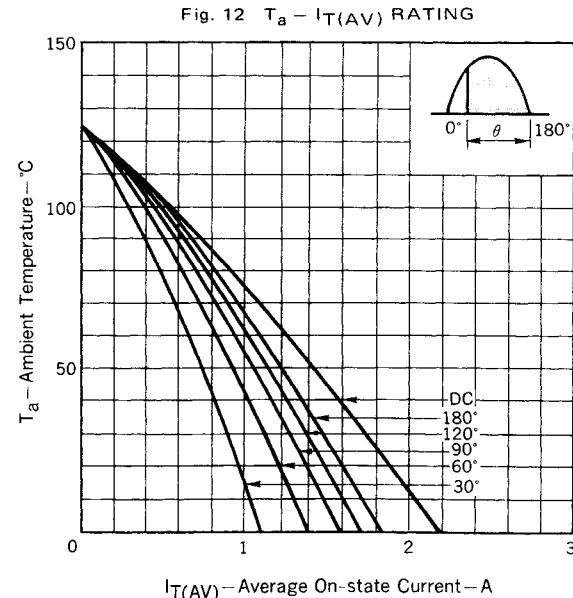
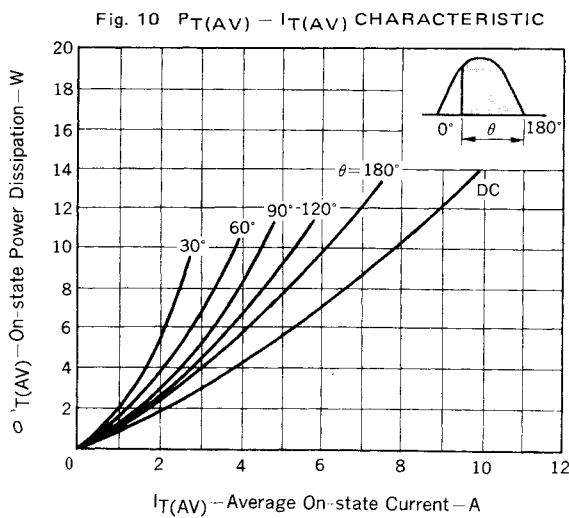
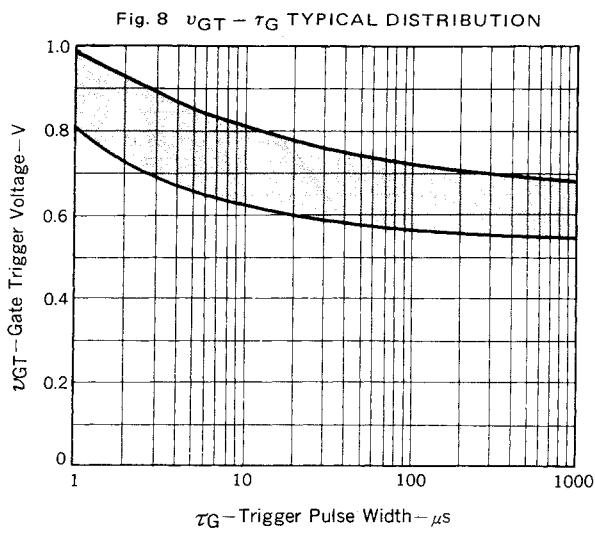
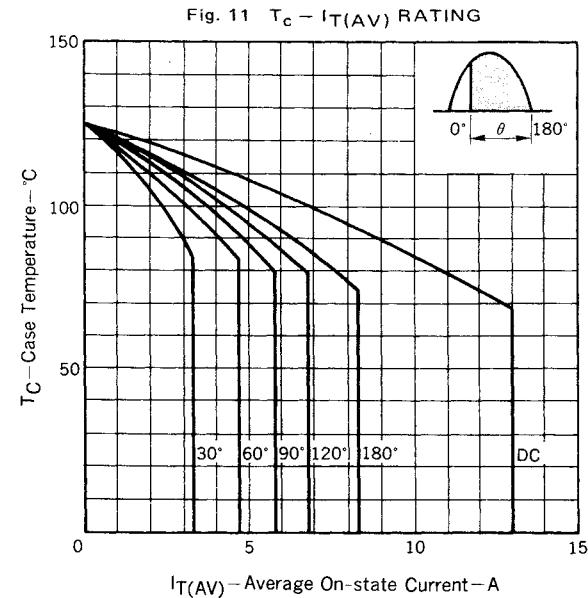
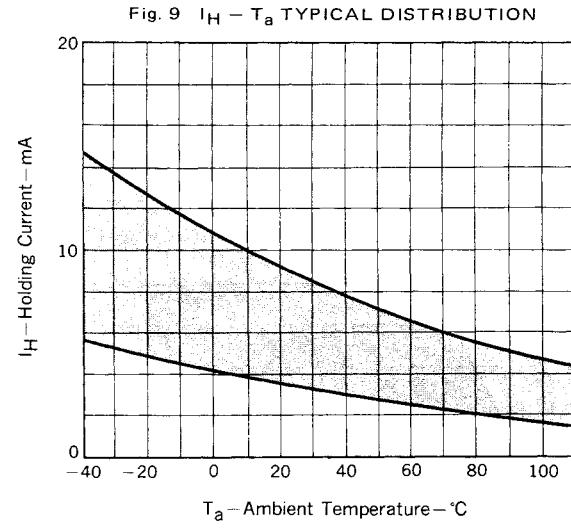
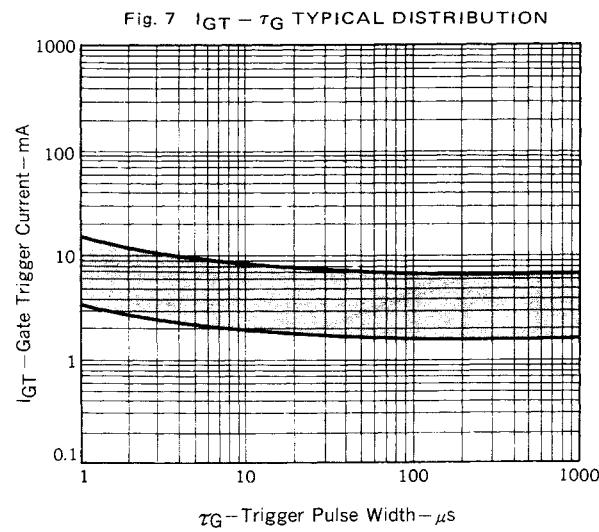


Fig. 13 Z_{th} CHARACTERISTIC